



V.H.F. POWER TRANSISTOR

N-P-N silicon planar epitaxial transistor intended for use in class-A, B or C operated mobile transmitters with a nominal supply voltage of 13,5 V. Because of the high gain and excellent power handling capability, the transistor is especially suited for design of wide-band and semi-wide-band v.h.f. amplifiers. Together with a BFQ43 driver stage, the chain can deliver 28 W with a maximum drive power of 250 mW at 175 MHz. The transistor is resistance stabilized and is guaranteed to withstand severe load mismatch conditions with a supply over-voltage to 16,5 V.

It has a 3/8" capstan envelope with a ceramic cap. All leads are isolated from the stud.

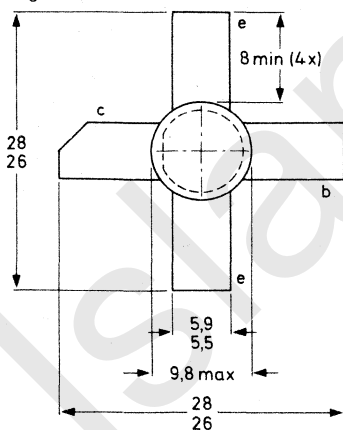
QUICK REFERENCE DATA

R.F. performance up to $T_h = 25^\circ\text{C}$

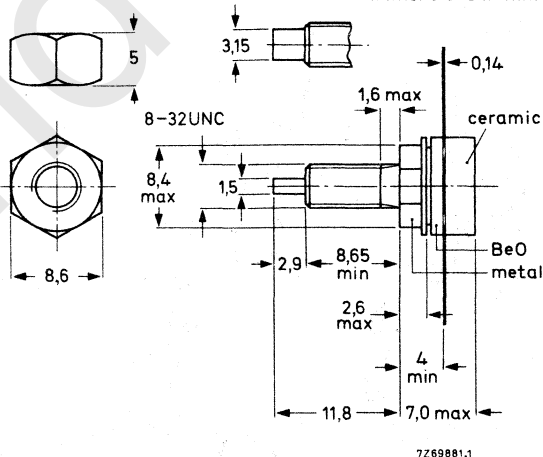
mode of operation	V_{CE} V	f MHz	P_L W	G_p dB	η %	\bar{z}_i Ω	\bar{Y}_L mA/V
c.w. class-B	13,5	175	28	> 9	> 60	$0,9 + j0,9$	$380 + j40$
c.w. class-B	12,5	175	28	typ. 9,5	typ. 70	—	—

MECHANICAL DATA

Fig. 1 SOT-120.



Dimensions in mm



Torque on nut: min. 0,75 Nm
(7,5 kg cm)
max. 0,85 Nm
(8,5 kg cm)

Diameter of clearance hole in heatsink: max. 4,2 mm.
Mounting hole to have no burrs at either end.
De-burring must leave surface flat; do not chamfer or countersink either end of hole.

When locking is required an adhesive is preferred instead of a lock washer.

CAUTION This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Collector-emitter voltage ($V_{BE} = 0$)
peak value

Collector-emitter voltage (open base)

Emitter-base voltage (open collector)

Collector current (average)

Collector current (peak value); $f > 1$ MHzR.F. power dissipation ($f > 1$ MHz); $T_{mb} = 25$ °C

Storage temperature

Operating junction temperature

V_{CESM}	max.	36 V
V_{CEO}	max.	18 V
V_{EBO}	max.	4 V
$I_C(AV)$	max.	6 A
I_{CM}	max.	15 A
P_{rf}	max.	96 W
T_{stg}		-65 to +150 °C
T_j	max.	200 °C

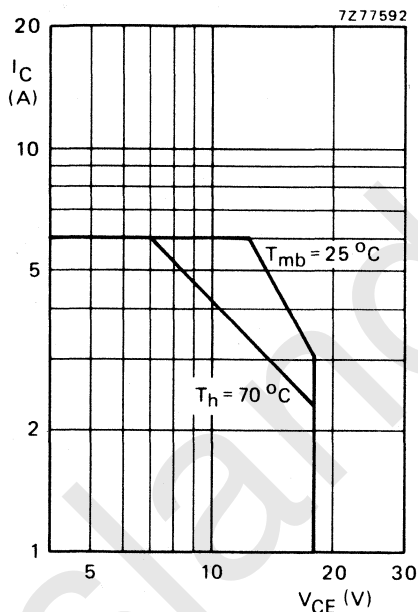
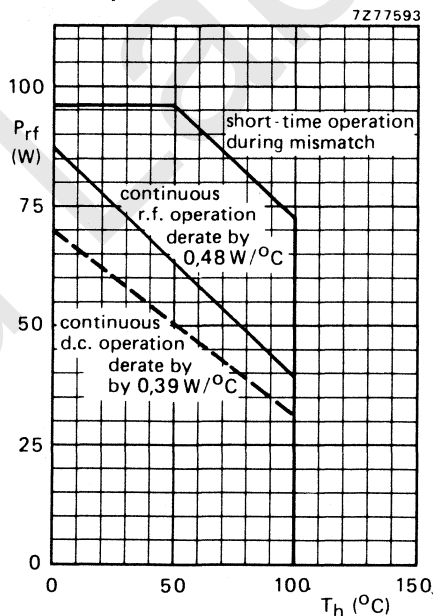


Fig. 2 D.C. SOAR.

Fig. 3 R.F. power dissipation; $V_{CE} \leq 16,5$ V;
 $f \geq 1$ MHz.**THERMAL RESISTANCE** (dissipation = 25 W; $T_{mb} = 81$ °C, i.e. $T_h = 70$ °C)

From junction to mounting base (d.c. dissipation)

$$R_{th\ j-mb(dc)} = 2,4 \text{ °C/W}$$

From junction to mounting base (r.f. dissipation)

$$R_{th\ j-mb(rf)} = 1,85 \text{ °C/W}$$

From mounting base to heatsink

$$R_{th\ mb-h} = 0,45 \text{ °C/W}$$

CHARACTERISTICS

 $T_j = 25\text{ }^{\circ}\text{C}$

Collector-emitter breakdown voltage

 $V_{BE} = 0; I_C = 25\text{ mA}$ $V_{(BR)CES} > 36\text{ V}$

Collector-emitter breakdown voltage

open base; $I_C = 100\text{ mA}$ $V_{(BR)CEO} > 18\text{ V}$

Emitter-base breakdown voltage

open collector; $I_E = 10\text{ mA}$ $V_{(BR)EBO} > 4\text{ V}$

Collector cut-off current

 $V_{BE} = 0; V_{CE} = 18\text{ V}$ $I_{CES} < 10\text{ mA}$ Second breakdown energy; $L = 25\text{ mH}; f = 50\text{ Hz}$

open base

 $R_{BE} = 10\text{ }\Omega$ $E_{SBO} > 8\text{ mJ}$ $E_{SBR} > 8\text{ mJ}$

D.C. current gain*

 $I_C = 3,5\text{ A}; V_{CE} = 5\text{ V}$ h_{FE} typ. 40

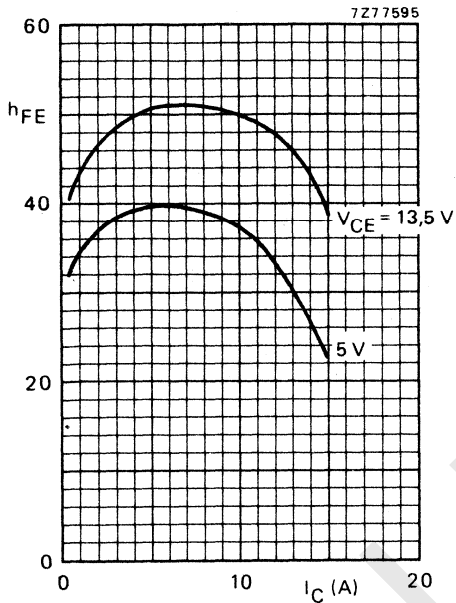
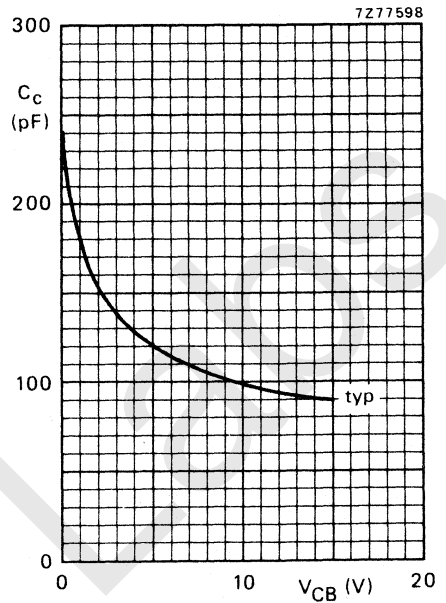
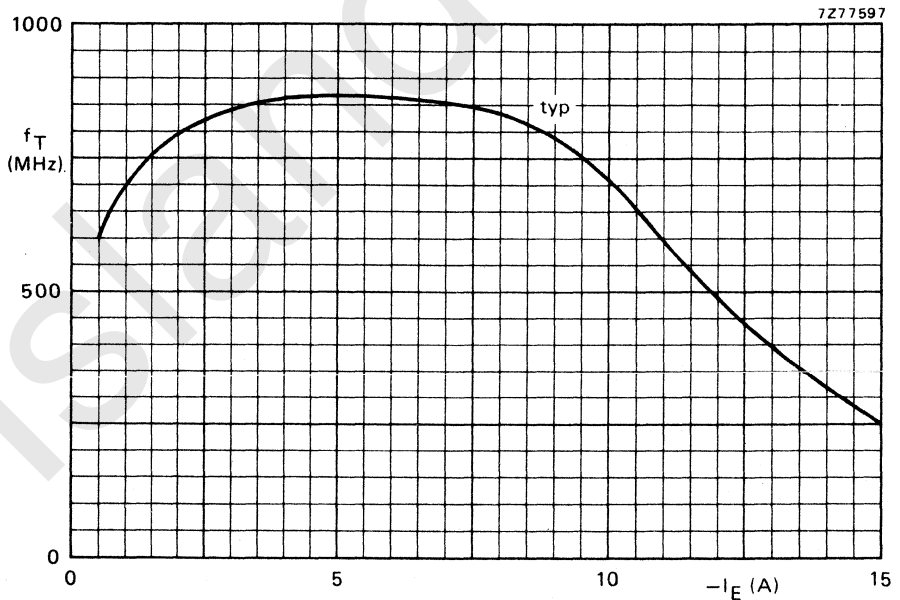
10 to 80

Collector-emitter saturation voltage*

 $I_C = 10\text{ A}; I_B = 2\text{ A}$ V_{CEsat} typ. 1,8 VTransition frequency at $f = 100\text{ MHz}$ * $-I_E = 3,5\text{ A}; V_{CB} = 13,5\text{ V}$ $-I_E = 10\text{ A}; V_{CB} = 13,5\text{ V}$ f_T typ. 850 MHz f_T typ. 700 MHzCollector capacitance at $f = 1\text{ MHz}$ $I_E = I_e = 0; V_{CB} = 13,5\text{ V}$ C_c typ. 92 pFFeedback capacitance at $f = 1\text{ MHz}$ $I_C = 100\text{ mA}; V_{CE} = 13,5\text{ V}$ C_{re} typ. 58 pF

Collector-stud capacitance

 C_{cs} typ. 2 pF* Measured under pulse conditions: $t_p \leq 200\text{ }\mu\text{s}; \delta \leq 0,02$.

Fig. 4 Typical values; $T_j = 25 \text{ }^\circ\text{C}$.Fig. 5 $I_E = I_e = 0$; $f = 1 \text{ MHz}$; $T_j = 25 \text{ }^\circ\text{C}$.Fig. 6 $V_{CB} = 13,5 \text{ V}$; $f = 100 \text{ MHz}$; $T_j = 25 \text{ }^\circ\text{C}$.

APPLICATION INFORMATION

R.F. performance in c.w. operation (unneutralized common-emitter class-B circuit)

 $T_h = 25^\circ\text{C}$

f (MHz)	V_{CE} (V)	P_L (W)	P_S (W)	G_p (dB)	I_C (A)	η (%)	\bar{z}_i (Ω)	\bar{Y}_L (mA/V)
175	13,5	28	< 3,5	> 9	< 3,45	> 60	$0,9 + j0,9$	$380 + j40$
175	12,5	28	typ. 3,15	typ. 9,5	typ. 3,2	typ. 70	—	—

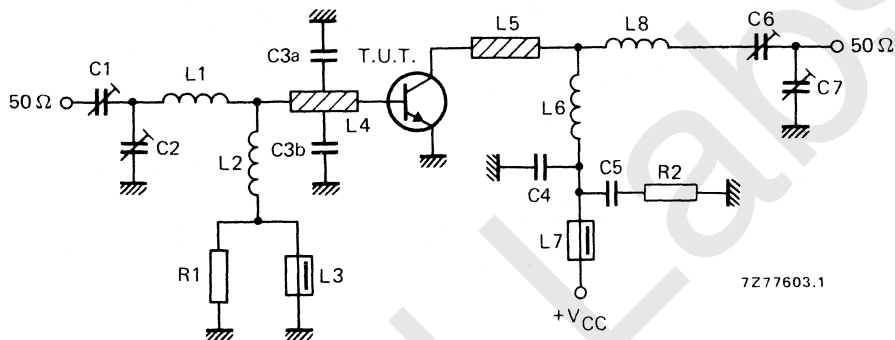


Fig. 7 Test circuit; c.w. class-B.

List of components:

C1 = 2,5 to 20 pF film dielectric trimmer (cat. no. 2222 809 07004)

C2 = C7 = 4 to 40 pF film dielectric trimmer (cat. no. 2222 809 07008)

C3a = C3b = 47 pF ceramic capacitor (500 V)

C4 = 120 pF ceramic capacitor

C5 = 100 nF polyester capacitor

C6 = 7 to 100 pF film dielectric trimmer (cat. no. 2222 809 07015)

L1 = $\frac{1}{2}$ turn Cu wire (1,6 mm); int. dia. 6,0 mm; leads 2 x 5 mm

L2 = 100 nH; 7 turns closely wound enamelled Cu wire (0,5 mm); int. dia. 3 mm; leads 2 x 5 mm

L3 = L7 = Ferroxcube wide-band h.f. choke, grade 3B (cat. no. 4312 020 36640)

L4 = L5 = strip (12 mm x 6 mm); taps for C3a and C3b at 5 mm from transistor

L6 = $3\frac{1}{2}$ turns closely wound enamelled Cu wire (1,6 mm) int. dia. 6,0 mm; leads 2 x 5 mm

L8 = 1 turn Cu wire (1,6 mm) int. dia. 6,0 mm; leads 2 x 5 mm

L4 and L5 are strips on a double Cu-clad printed-circuit board with epoxy fibre-glass dielectric, thickness 1/16".

R1 = R2 = 10 Ω carbon resistor

Component layout and printed-circuit board for 175 MHz test circuit are shown in Fig. 8.



The circuit and the components are situated on one side of the epoxy fibre-glass board, the other side being fully metallized to serve as earth. Earth connections are made by means of hollow rivets, whilst under the emitter leads Cu straps are used for a direct contact between upper and lower sheets.

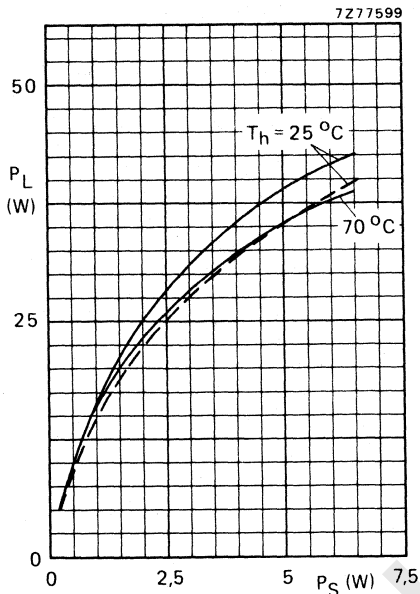


Fig. 9 Typical values; $f = 175 \text{ MHz}$;
 — $V_{CE} = 13,5 \text{ V}$; --- $V_{CE} = 12,5 \text{ V}$.

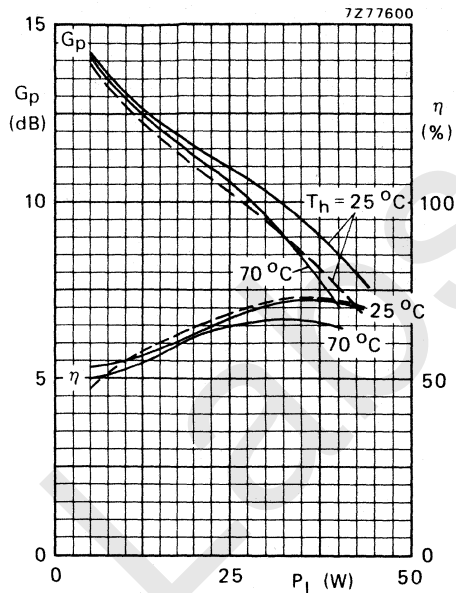


Fig. 10 Typical values; $f = 175 \text{ MHz}$;
 — $V_{CE} = 13,5 \text{ V}$; --- $V_{CE} = 12,5 \text{ V}$.

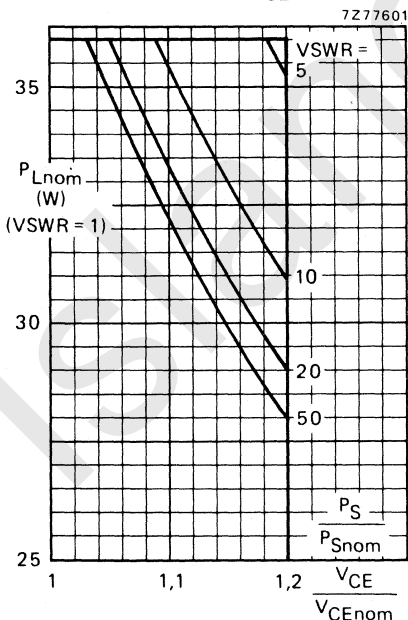


Fig. 11 R.F. SOAR (short-time operation during mismatch); $f = 175 \text{ MHz}$; $T_h = 70 \text{ °C}$; $R_{th \text{ mb-h}} = 0,45 \text{ °C/W}$; $V_{CEnom} = 13,5 \text{ V}$ or $12,5 \text{ V}$; $P_S = P_{Snom}$ at V_{CEnom} and $V_{SWR} = 1$ (see page 5).

The transistor has been developed for use with unstabilized supply voltages. As the output power and drive power increase with the supply voltage, the nominal output power must be derated in accordance with the graph for safe operation at supply voltages other than the nominal. The graph shows the permissible output power under nominal conditions ($V_{SWR} = 1$), as a function of the expected supply over-voltage ratio with V_{SWR} as parameter.

The graph applies to the situation in which the drive (P_S/P_{Snom}) increases linearly with supply over-voltage ratio.

OPERATING NOTE Below 50 MHz a base-emitter resistor of 10 Ω is recommended to avoid oscillation. This resistor must be effective for r.f. only.

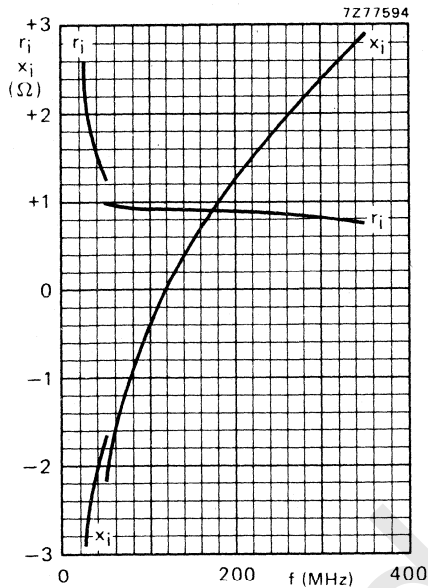


Fig. 12.

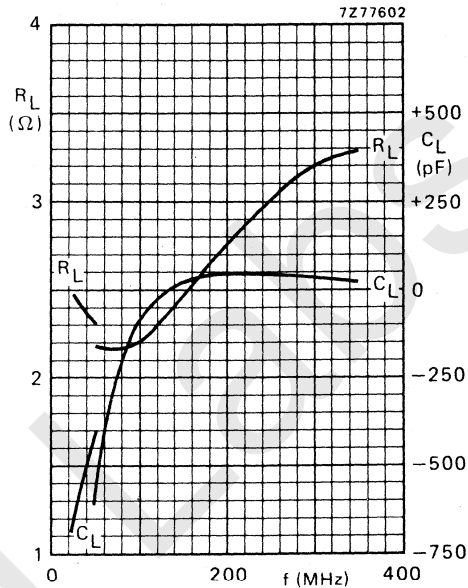
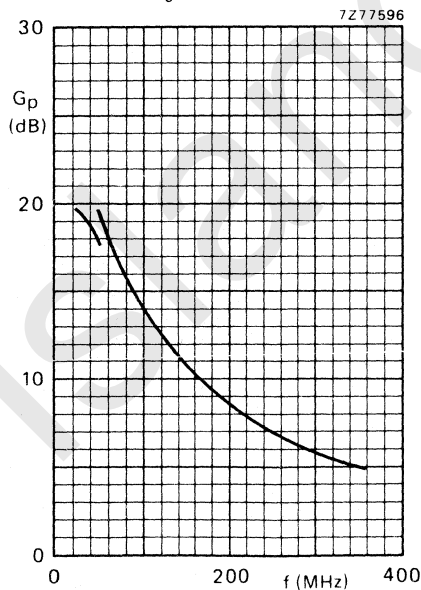


Fig. 13.



Conditions for Figs 12, 13 and 14:
Typical values; $V_{CE} = 13,5$ V; $P_L = 28$ W;
 $T_h = 25$ $^{\circ}$ C.

Fig. 14.